Vishay Siliconix

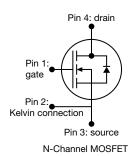
COMPLIANT

HALOGEN

FREE

E Series Power MOSFET





| PRODUCT SUMMARY | | | | |
|--------------------------------------------|------------------------|-------|--|--|
| V _{DS} (V) at T _J max. | 650 | | | |
| R _{DS(on)} typ. (Ω) at 25 °C | V _{GS} = 10 V | 0.059 | | |
| Q _g max. (nC) | 80 | | | |
| Q _{gs} (nC) | 17 | | | |
| Q _{gd} (nC) | 20 | | | |
| Configuration | Single | | | |

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

| ORDERING INFORMATION | |
|---------------------------------|--------------------|
| Package | PowerPAK 8 x 8 |
| Lead (Pb)-free and halogen-free | SiHH068N60E-T1-GE3 |

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | |
|----------------------------------------------------------------------------------|----------------------------------------------------------------|-----------------------------------|-------------|-------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Drain-source voltage | | V _{DS} | 600 | V | |
| Gate-source voltage | V _{GS} | ± 30 | 1 v | | |
| Continuous drain current (T _J = 150 °C) | V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$ | I _D | 34 | А | |
| | V_{GS} at 10 V_{C} $T_{C} = 100 ^{\circ}$ C | | 22 | | |
| Pulsed drain current ^a | I _{DM} | 100 | | | |
| Linear derating factor | | | 1.6 | W/°C | |
| Single pulse avalanche energy b | | E _{AS} | 226 | mJ | |
| Maximum power dissipation | | P _D | 202 | W | |
| Operating junction and storage temperature range | e | T _J , T _{stg} | -55 to +150 | °C | |
| Drain-source voltage slope | T _J = 125 °C | dv/dt | 70 | V/ns | |
| Reverse diode dv/dt ^c | | uv/at | 50 | V/115 | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4.0 A
- c. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C



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| THERMAL RESISTANCE RATINGS | | | | |
|----------------------------------|-------------------|------|------|-------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum junction-to-ambient | R _{thJA} | 38 | 50 | °C/W |
| Maximum junction-to-case (drain) | R _{thJC} | 0.48 | 0.62 | C/ VV |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|-----------------------------------------------------------|-----------------------|----------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------|------|-------|-------|------|
| Static | | | | | | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 600 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | Reference to 25 °C, I _D = 1 mA | | 0.56 | - | V/°C |
| Gate-source threshold voltage (N) | V _{GS(th)} | V _{DS} = | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | | - | 5.0 | V |
| | I _{GSS} | , | $V_{GS} = \pm 20 \text{ V}$ | | - | ± 100 | nA |
| Gate-source leakage | | , | $V_{GS} = \pm 30 \text{ V}$ | - | - | ± 1 | μΑ |
| Zava sata valtasa duain ayuwant | | V _{DS} = | 600 V, V _{GS} = 0 V | - | - | 1 | |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 480 V | V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C | | - | 10 | μA |
| Drain-source on-state resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 15 A | - | 0.059 | 0.068 | Ω |
| Forward transconductance a | 9 _{fs} | V _{DS} = 20 V, I _D = 15 A | | - | 9.3 | - | S |
| Dynamic | | | | | | • | |
| Input capacitance | C _{iss} | V _{GS} = 0 V, | | - | 2650 | - | pF |
| Output capacitance | C _{oss} | Τ, | V _{DS} = 0 V, | | 113 | - | |
| Reverse transfer capacitance | C _{rss} | f = 1 MHz | | - | 6 | - | |
| Effective output capacitance, energy related ^a | C _{o(er)} | V 0VV 400V V 0V | | - | 94 | - | |
| Effective output capacitance, time related ^b | C _{o(tr)} | V _{DS} = 0 V | $V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$ | | 591 | - | |
| Total gate charge | Qg | | | - | 53 | 80 | nC |
| Gate-source charge | Q _{gs} | V _{GS} = 10 V | $V_{GS} = 10 \text{ V}$ $I_D = 15 \text{ A}, V_{DS} = 480 \text{ V}$ | - | 17 | - | |
| Gate-drain charge | Q _{gd} | 7 | | | 20 | - | |
| Turn-on delay time | t _{d(on)} | | V _{DD} = 480 V, I _D = 15 A, | | 56 | 84 | |
| Rise time | t _r | V _{DD} = | | | 148 | 222 | |
| Turn-off delay time | t _{d(off)} | | $= 10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \Omega$ | - | 60 | 90 | ns |
| Fall time | t _f | 1 | | - | 30 | 60 | |
| Gate input resistance | Rg | f = 1 MHz, open drain | | 0.3 | 0.7 | 1.4 | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous source-drain diode current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 34 | |
| Pulsed diode forward current | I _{SM} | | | - | - | 100 | A |
| Diode forward voltage | V _{SD} | T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V | | - | - | 1.2 | V |
| Reverse recovery time | t _{rr} | $T_J = 25 \text{ °C}, I_F = I_S = 15 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$ | | - | 377 | 754 | ns |
| Reverse recovery charge | Q _{rr} | | | - | 5.7 | 11.4 | μC |
| Reverse recovery current | I _{RRM} | | | _ | 25 | - | Α |

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

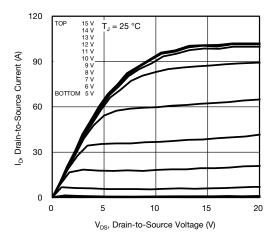


Fig. 1 - Typical Output Characteristics

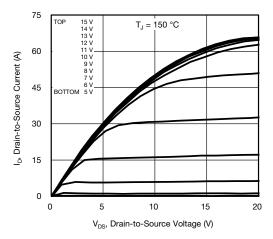


Fig. 2 - Typical Output Characteristics

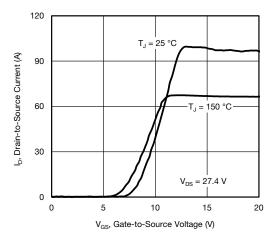


Fig. 3 - Typical Transfer Characteristics

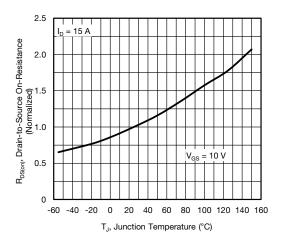


Fig. 4 - Normalized On-Resistance vs. Temperature

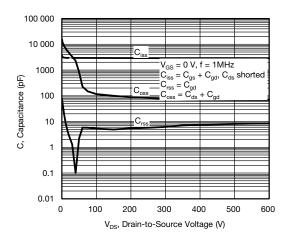


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

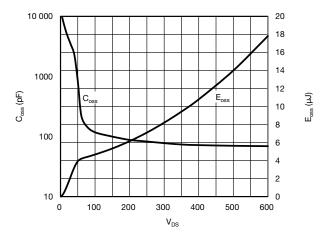


Fig. 6 - Coss and Eoss vs. VDS



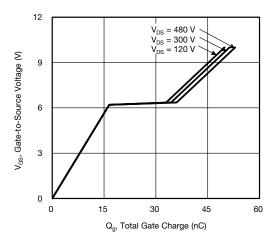


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

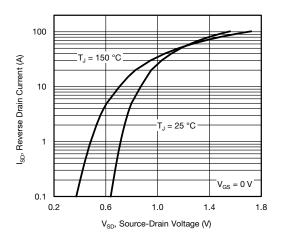


Fig. 8 - Typical Source-Drain Diode Forward Voltage

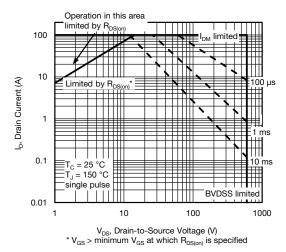


Fig. 9 - Maximum Safe Operating Area

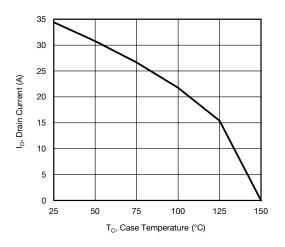


Fig. 10 - Maximum Drain Current vs. Case Temperature

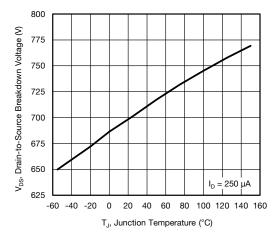


Fig. 11 - Temperature vs. Drain-to-Source Voltage



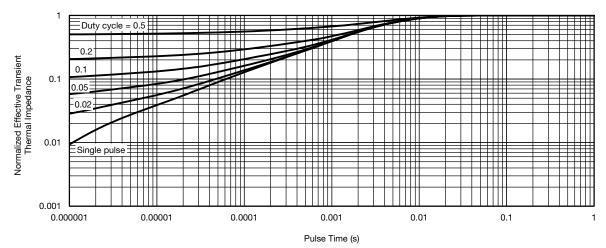


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

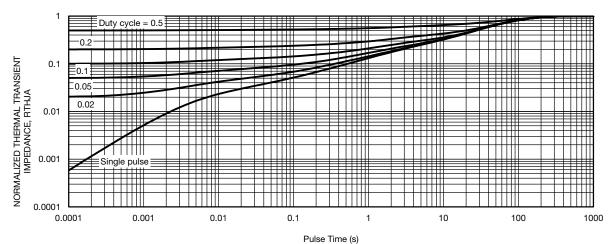


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

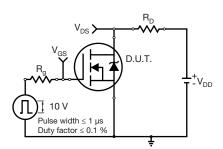


Fig. 14 - Switching Time Test Circuit

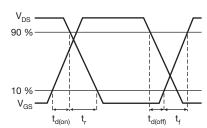


Fig. 15 - Switching Time Waveforms

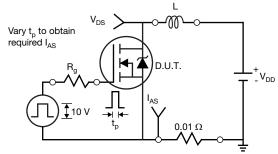


Fig. 16 - Unclamped Inductive Test Circuit

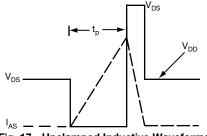


Fig. 17 - Unclamped Inductive Waveforms

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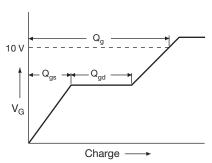


Fig. 18 - Basic Gate Charge Waveform

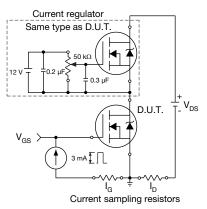
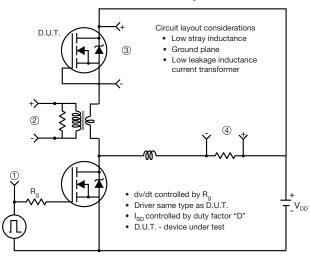


Fig. 19 - Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



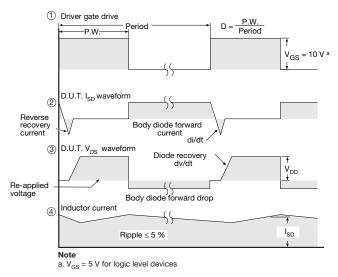


Fig. 20 - For N-Channel

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